

BB02-UG: 3.96mm (0.156") HEADER, STRAIGHT, THROUGH HOLE, SINGLE ROW - 02 to 24 CONTACTS

SPECIFICATIONS

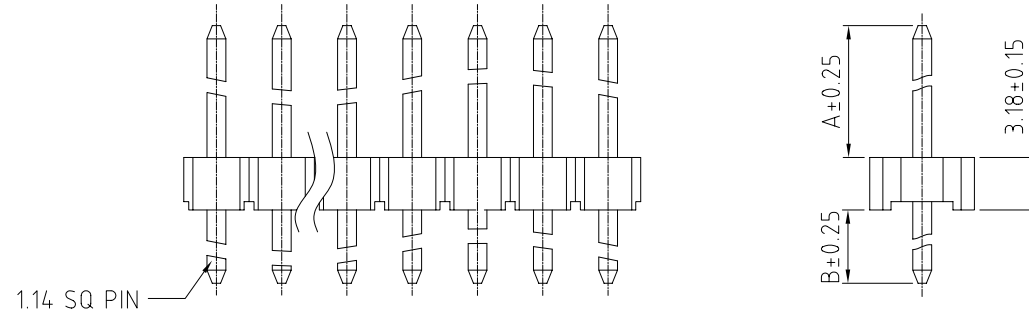
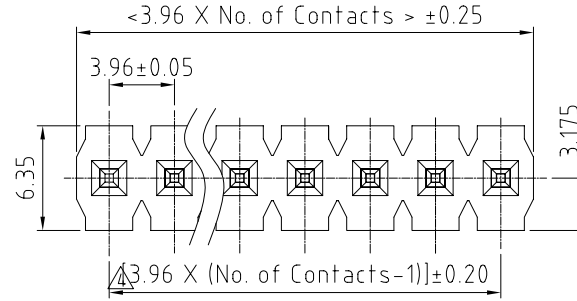
CURRENT RATING	7.9 AMP
INSULATOR RESISTANCE	5000 MEGOHMS MIN.
CONTACT RESISTANCE	20m ohms MAX.
DIELECTRIC WITHSTANDING	1500V AC/DC
OPERATING TEMPREATURE	-55°C TO +105°C
CONTACT MATERIAL	BRASS
INSULATOR MATERIAL	LCP, UL 94V-0
PLATING	MATT TIN OVER 30-50U" NICKEL
SOLDERABILITY	IR REFLOW: 280°C FOR 10 SEC
	WAVE: 250°C FOR 5-10 SEC
	MANUAL SOLDER: 380°C FOR 3-5 SEC

PACKAGE: BULK.

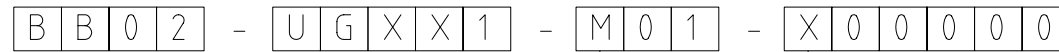
MATES WITH: - BB02-US
BB02-UT

NOTES:

1. GOLD FLASH PLATING IS AVAILABLE UPON REQUEST, PLEASE CONTACT US FOR MORE INFORMATION.



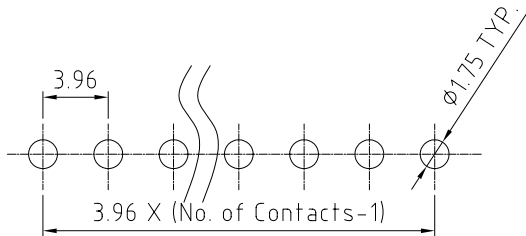
HOW TO ORDER



NO. OF CONTACTS
02 TO 24

CONTACT PLATING OPTIONS
M = MATT TIN (STANDARD)

- A: DIM. A=11.45, DIM. B=4.45
- B: DIM. A=12.70, DIM. B=4.45
- C: DIM. A=20.55, DIM. B=4.00
- D: DIM. A=3.80, DIM. B=12.10
- E: DIM. A=11.43, DIM. B=3.18
- △F: DIM. A=17.30, DIM. B=3.50



(TOLERANCE: ±0.05)
RECOMMENDED PC BOARD LAYOUT

REV. DATE & DRN 10. 15/06/07 - CHC RELEASE 11. 02/06/08 - CHC PLATING MODIFICATION 12. 25/07/08 - NYW DRAWING MODIFICATION 13. 05/03/09 - NYW ADD OTHER PLATING OPTIONS ADD NOTES 1 14. 23/10/09 - CHC ADD PIN LENGTH OPTION "F"	Scale: 3:1 Drawn: CHC App'd: XXXX Date: 21 OCT '09	THIRD ANGLE Title: HEADER Revision: 1.4	Unstated Tolerances: X. ± 0.30 .X ± 0.25 .XX ± 0.15 .XXX ± 0.10	Material: SEE NOTE NOT TO SCALE Unit: mm	 www.gradconn.com	Type: BB02-UG BB02-UG Drawing Number: Sheet 1 of 1 Drawing © E and O E
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